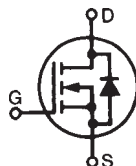


TrenchMV™ Power MOSFET

IXTA180N10T
IXTP180N10T

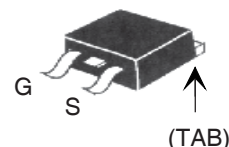
N-Channel Enhancement Mode
Avalanche Rated



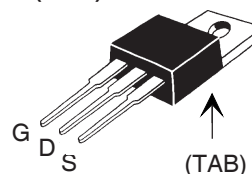
$$\begin{aligned} V_{DSS} &= 100V \\ I_{D25} &= 180A \\ R_{DS(on)} &\leq 6.4m\Omega \end{aligned}$$

| Symbol | Test Conditions | Maximum Ratings | |
|------------|-------------------------------------------------------------------|-----------------|------------------|
| V_{DSS} | $T_J = 25^\circ\text{C to } 175^\circ\text{C}$ | 100 | V |
| V_{DGR} | $T_J = 25^\circ\text{C to } 175^\circ\text{C}, R_{GS} = 1M\Omega$ | 100 | V |
| V_{GSM} | Transient | ± 30 | V |
| I_{D25} | $T_C = 25^\circ\text{C}$ | 180 | A |
| I_{LRMS} | Lead Current limit, RMS | 75 | A |
| I_{DM} | $T_C = 25^\circ\text{C}$, pulse width limited by T_{JM} | 450 | A |
| I_{AR} | $T_C = 25^\circ\text{C}$ | 25 | A |
| E_{AS} | $T_C = 25^\circ\text{C}$ | 750 | mJ |
| P_D | $T_C = 25^\circ\text{C}$ | 480 | W |
| T_J | | -55 ... +175 | $^\circ\text{C}$ |
| T_{JM} | | 175 | $^\circ\text{C}$ |
| T_{stg} | | -55 ... +175 | $^\circ\text{C}$ |
| T_L | 1.6mm (0.062in.) from case for 10s | 300 | $^\circ\text{C}$ |
| T_{SOLD} | Plastic body for 10 seconds | 260 | $^\circ\text{C}$ |
| M_d | Mounting torque (TO-220) | 1.13/10 | Nm/lb.in |
| Weight | TO-263 | 2.5 | g |
| | TO-220 | 3.0 | g |

TO-263 (IXTA)



TO-220 (IXTP)



G = Gate D = Drain
S = Source TAB = Drain

Features

- Ultra-low On Resistance
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
 - easy to drive and to protect
- 175 $^\circ\text{C}$ Operating Temperature

Advantages

- Easy to mount
- Space savings
- High power density

Applications

- Automotive
 - Motor Drives
 - 42V Power Bus
 - ABS Systems
- DC/DC Converters and Off-line UPS
- Primary Switch for 24V and 48V Systems
- Distributed Power Architectures and VRMs
- Electronic Valve Train Systems
- High Current Switching Applications
- High Voltage Synchronous Rectifier

| Symbol | Test Conditions ($T_J = 25^\circ\text{C}$ unless otherwise specified) | Characteristic Values | | |
|--------------|---------------------------------------------------------------------------|-----------------------|------|----------------|
| | | Min. | Typ. | Max. |
| BV_{DSS} | $V_{GS} = 0V, I_D = 250\mu A$ | 100 | | V |
| $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\mu A$ | 2.5 | | 4.5 V |
| I_{GSS} | $V_{GS} = \pm 20V, V_{DS} = 0V$ | | | ± 100 nA |
| I_{DSS} | $V_{DS} = V_{DSS}$ | | | 5 μA |
| | $V_{GS} = 0V, T_J = 150^\circ\text{C}$ | | | 100 μA |
| $R_{DS(on)}$ | $V_{GS} = 10V, I_D = 25A$, Notes 1, 2 | | 5.7 | 6.4 m Ω |

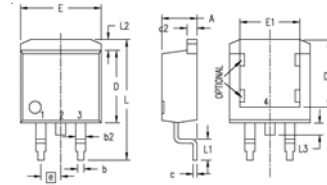
| Symbol | Test Conditions | Characteristic Values | | |
|----------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------|------|-----------|
| | | Min. | Typ. | Max. |
| (T _J = 25°C unless otherwise specified) | | | | |
| g_{fs} | V _{DS} = 10V, I _D = 60A, Note 1 | 70 | 110 | S |
| C_{iss} | V _{GS} = 0V, V _{DS} = 25V, f = 1MHz | | 6900 | pF |
| C_{oss} | | | 923 | pF |
| C_{rss} | | | 162 | pF |
| t_{d(on)} | Resistive Switching Times V _{GS} = 10V, V _{DS} = 0.5 • V _{DSS} , I _D = 25A R _G = 3.3Ω (External) | | 33 | ns |
| t_r | | | 54 | ns |
| t_{d(off)} | | | 42 | ns |
| t_f | | | 31 | ns |
| Q_{g(on)} | V _{GS} = 10V, V _{DS} = 0.5 • V _{DSS} , I _D = 25A | | 151 | nC |
| Q_{gs} | | | 39 | nC |
| Q_{gd} | | | 45 | nC |
| R_{thJC} | TO-220 | | 0.50 | 0.31 °C/W |
| R_{thCH} | | | | °C/W |

Source-Drain Diode

| Symbol | Test Conditions (T _J = 25°C unless otherwise specified) | Characteristic Values | | |
|-----------------|-----------------------------------------------------------------------------------------------------------|-----------------------|------|--------|
| | | Min. | Typ. | Max. |
| I _S | V _{GS} = 0V | | | 180 A |
| I _{SM} | Repetitive, pulse width limited by T _{JM} | | | 450 A |
| V _{SD} | I _F = 25A, V _{GS} = 0V, Note 1 | | | 0.95 V |
| t _{rr} | I _F = 90A, V _{GS} = 0V -di/dt = 100A/μs V _R = 0.5 • V _{DSS} | | 72 | ns |
| I _{RM} | | | 5.1 | A |
| Q _{RM} | | | 0.18 | μC |

- Notes: 1. Pulse test, t ≤ 300μs, duty cycle, d ≤ 2%.
2. On through-hole packages, R_{DS(on)} Kelvin test contact location must be 5mm or less from the package body.

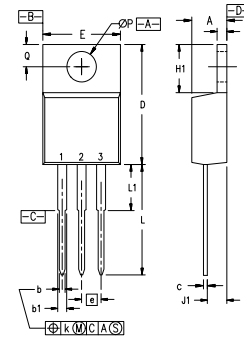
TO-263 (IXTA) Outline



Pins: 1 - Gate 2 - Drain
3 - Source 4, TAB - Drain

| Dim. | Millimeter | | Inches | |
|------|------------|-------|--------|------|
| | Min. | Max. | Min. | Max. |
| A | 4.06 | 4.83 | .160 | .190 |
| A1 | 2.03 | 2.79 | .080 | .110 |
| b | 0.51 | 0.99 | .020 | .039 |
| b2 | 1.14 | 1.40 | .045 | .055 |
| c | 0.46 | 0.74 | .018 | .029 |
| c2 | 1.14 | 1.40 | .045 | .055 |
| D | 8.64 | 9.65 | .340 | .380 |
| D1 | 7.11 | 8.13 | .280 | .320 |
| E | 9.65 | 10.29 | .380 | .405 |
| E1 | 6.86 | 8.13 | .270 | .320 |
| e | 2.54 | BSC | .100 | BSC |
| L | 14.61 | 15.88 | .575 | .625 |
| L1 | 2.29 | 2.79 | .090 | .110 |
| L2 | 1.02 | 1.40 | .040 | .055 |
| L3 | 1.27 | 1.78 | .050 | .070 |
| L4 | 0 | 0.38 | 0 | .015 |
| R | 0.46 | 0.74 | .018 | .029 |

TO-220 (IXTP) Outline



Pins: 1 - Gate 2 - Drain
3 - Source 4, TAB - Drain

| SYM | INCHES | | MILLIMETERS | |
|-----|----------|------|-------------|-------|
| | MIN | MAX | MIN | MAX |
| A | .170 | .190 | 4.32 | 4.83 |
| b | .025 | .040 | 0.64 | 1.02 |
| b1 | .045 | .065 | 1.15 | 1.65 |
| c | .014 | .022 | 0.35 | 0.56 |
| D | .580 | .630 | 14.73 | 16.00 |
| E | .390 | .420 | 9.91 | 10.66 |
| e | .100 BSC | | 2.54 BSC | |
| F | .045 | .055 | 1.14 | 1.40 |
| H1 | .230 | .270 | 5.85 | 6.85 |
| J1 | .090 | .110 | 2.29 | 2.79 |
| k | 0 | .015 | 0 | 0.38 |
| L | .500 | .550 | 12.70 | 13.97 |
| L1 | .110 | .230 | 2.79 | 5.84 |
| ØP | .139 | .161 | 3.53 | 4.08 |
| Q | .100 | .125 | 2.54 | 3.18 |

IXYS reserves the right to change limits, test conditions, and dimensions.

| | | | | | | | | | | |
|----------------------------------------------------------------------------------|-----------|-----------|-----------|-----------|--------------|--------------|--------------|--------------|--------------|-------------|
| IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: | 4,835,592 | 4,931,844 | 5,049,961 | 5,237,481 | 6,162,665 | 6,404,065 B1 | 6,683,344 | 6,727,585 | 7,005,734 B2 | 7,157,338B2 |
| | 4,850,072 | 5,017,508 | 5,063,307 | 5,381,025 | 6,259,123 B1 | 6,534,343 | 6,710,405 B2 | 6,759,692 | 7,063,975 B2 | |
| | 4,881,106 | 5,034,796 | 5,187,117 | 5,486,715 | 6,306,728 B1 | 6,583,505 | 6,710,463 | 6,771,478 B2 | 7,071,537 | |

Fig. 1. Output Characteristics
@ 25°C

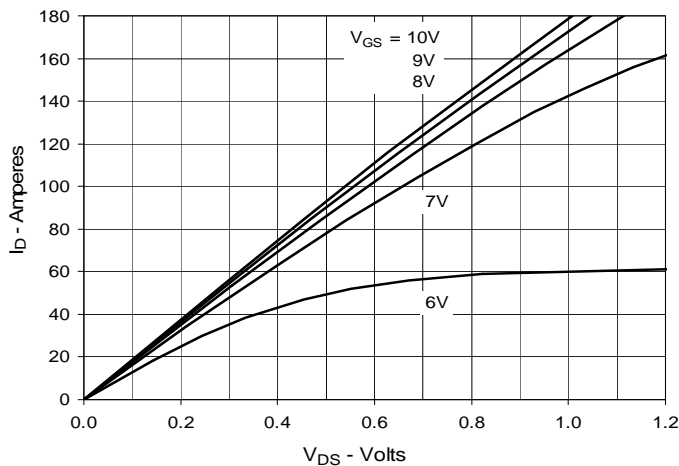


Fig. 2. Extended Output Characteristics
@ 25°C

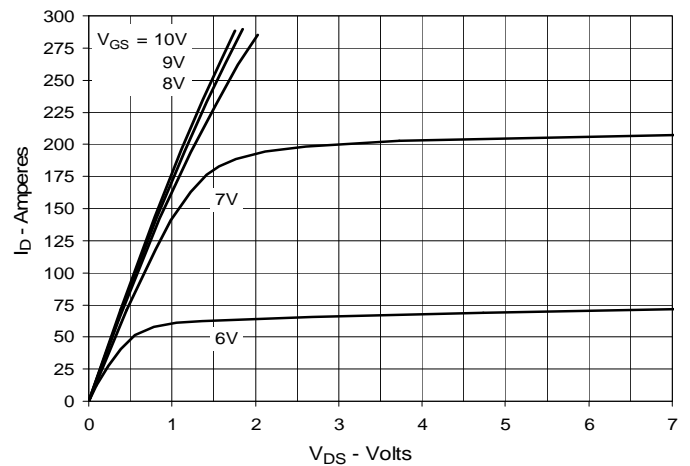


Fig. 3. Output Characteristics
@ 150°C

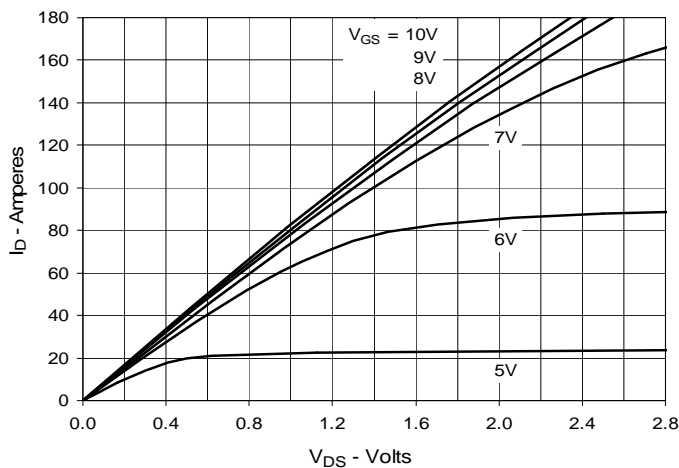


Fig. 4. $R_{DS(on)}$ Normalized to $I_D = 90A$ Value
vs. Junction Temperature

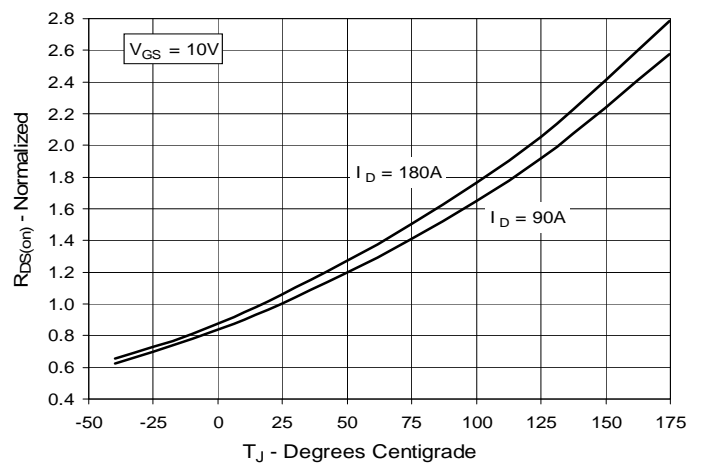


Fig. 5. $R_{DS(on)}$ Normalized to $I_D = 90A$ Value
vs. Drain Current

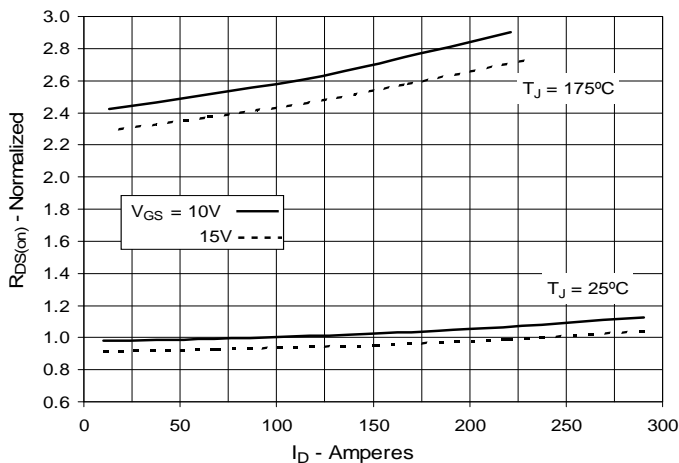


Fig. 6. Drain Current vs. Case Temperature

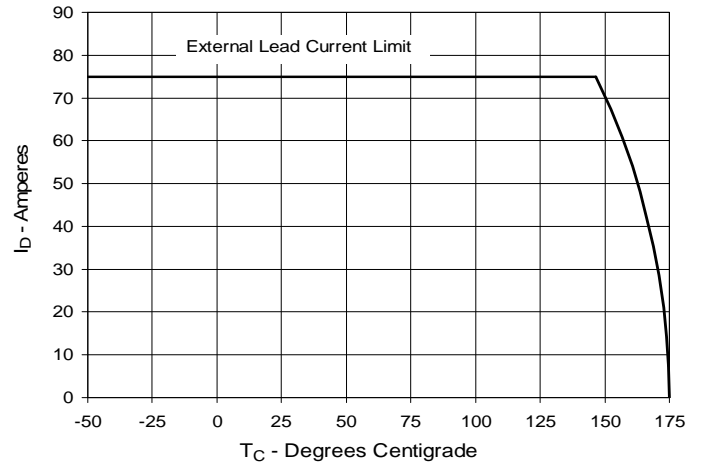


Fig. 7. Input Admittance

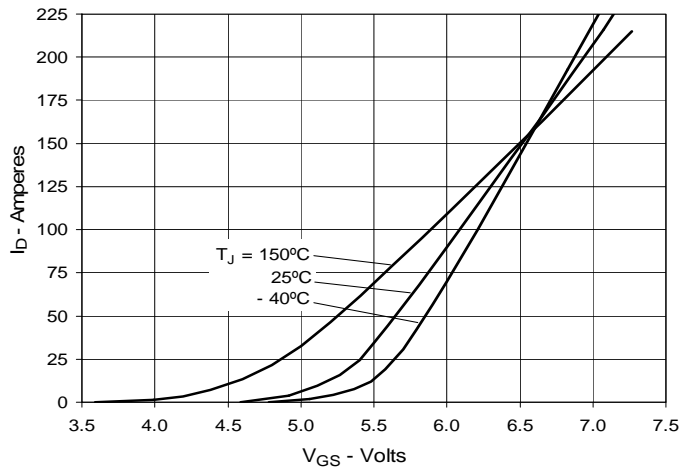


Fig. 8. Transconductance

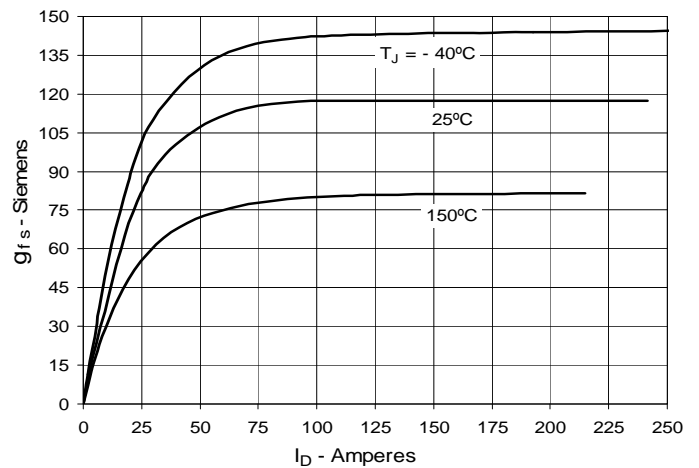


Fig. 9. Forward Voltage Drop of Intrinsic Diode

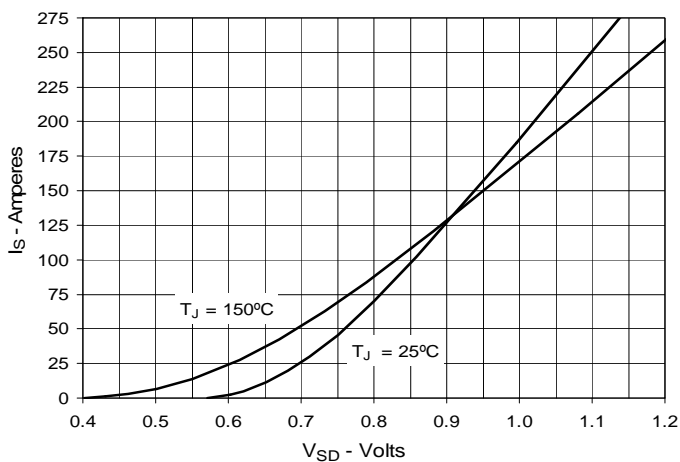


Fig. 10. Gate Charge

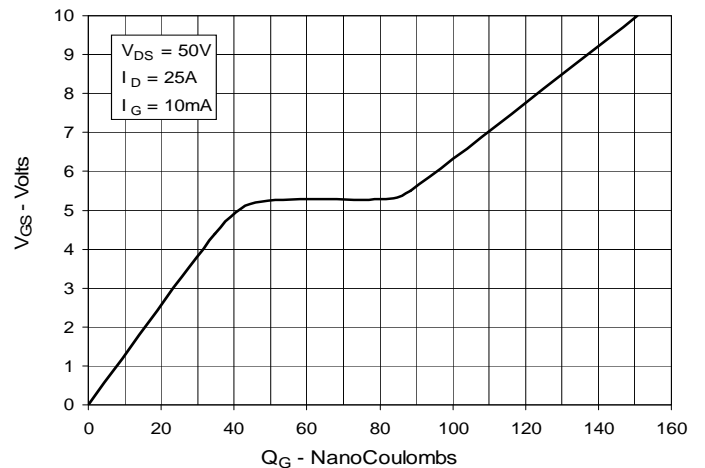


Fig. 11. Capacitance

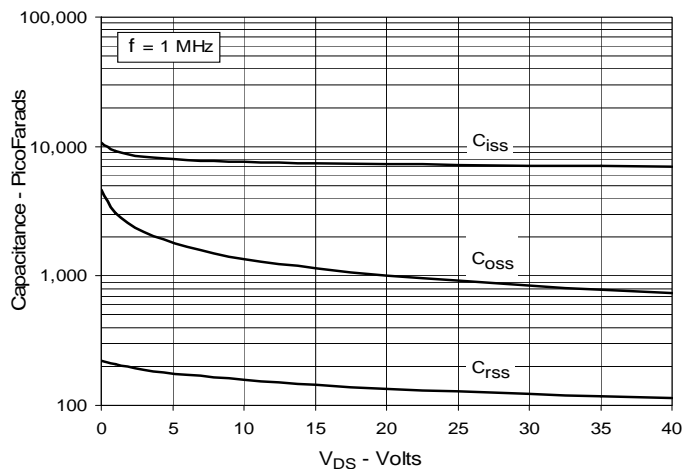
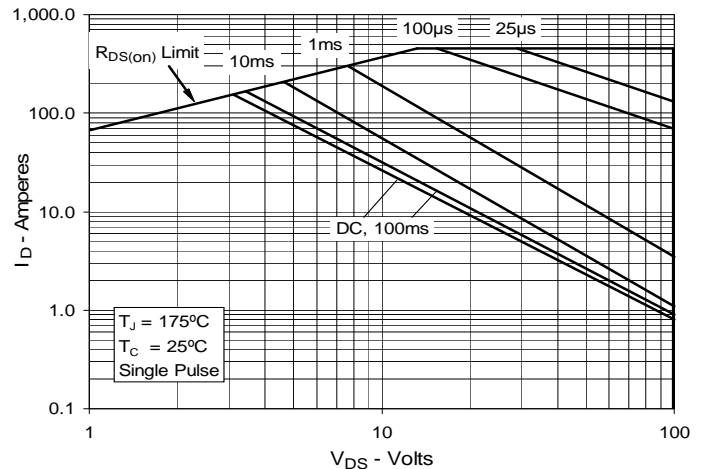
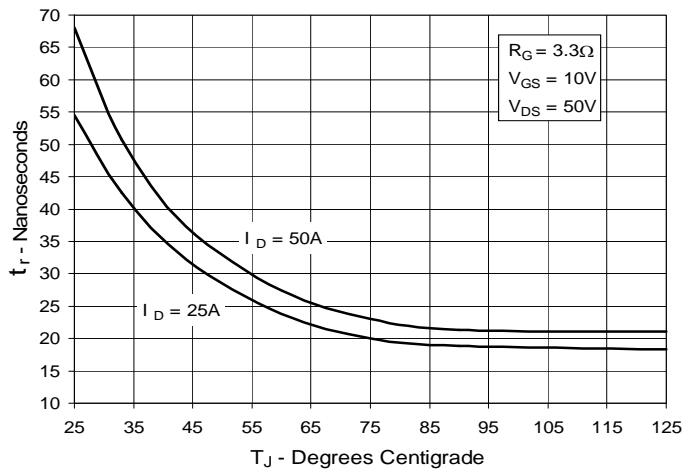


Fig. 12. Forward-Bias Safe Operating Area

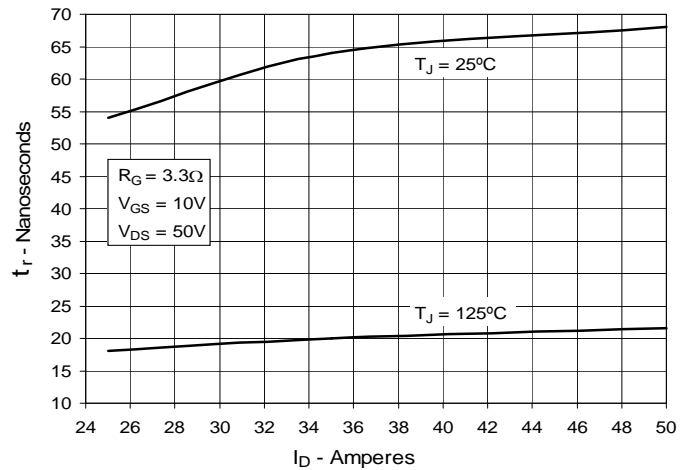


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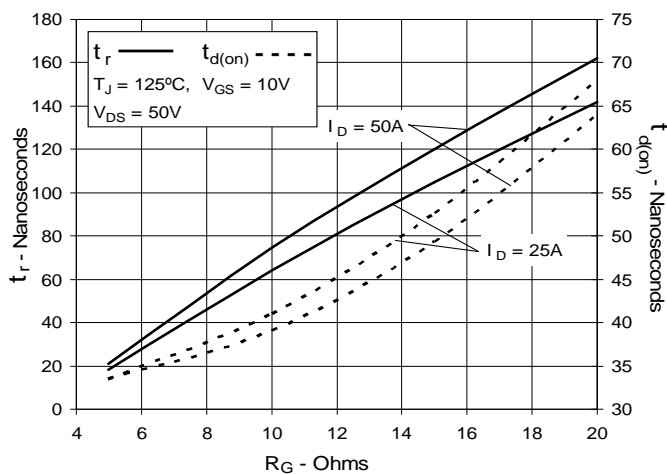
**Fig. 13. Resistive Turn-on
Rise Time vs. Junction Temperature**



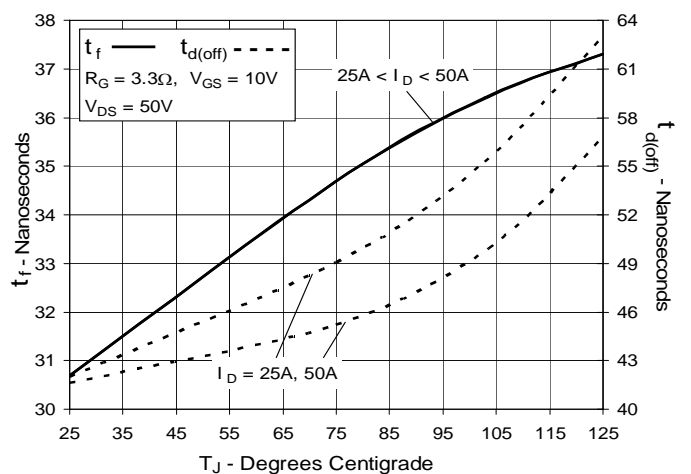
**Fig. 14. Resistive Turn-on
Rise Time vs. Drain Current**



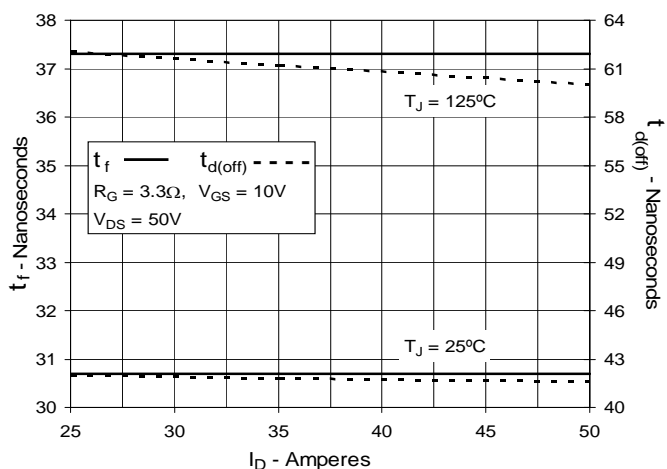
**Fig. 15. Resistive Turn-on
Switching Times vs. Gate Resistance**



**Fig. 16. Resistive Turn-off
Switching Times vs. Junction Temperature**



**Fig. 17. Resistive Turn-off
Switching Times vs. Drain Current**



**Fig. 18. Resistive Turn-off
Switching Times vs. Gate Resistance**

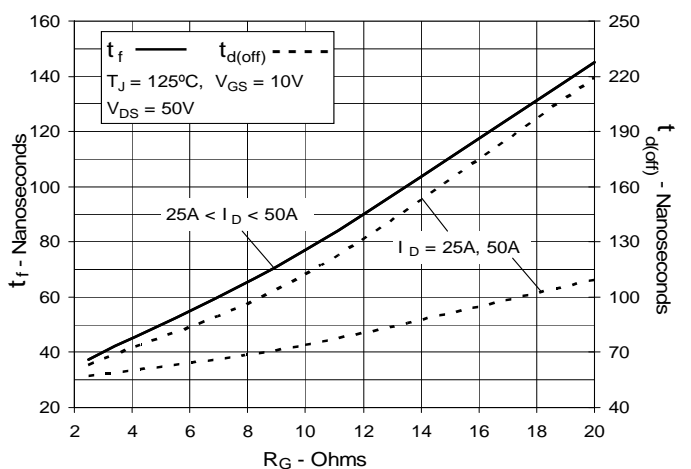


Fig. 19. Maximum Transient Thermal Impedance

